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Docket No.: 09792909-3401
Client: SONY CORPORATION
1st Inventor: TAYANAKA, Hiroshi
Title of Invention: METHOD FOR MAKING THIN FILM SEMICONDUCTOR
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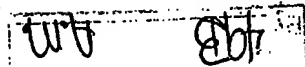


1. Disclaimer in Patent Under 37 CFR 1.321(a) (1 page);
2. Credit Card Payment Form (1 pg); and
2. Post card receipt (1).

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